

DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled MULTI-PLANAR CEILING SYSTEM, the specification of which:

 x is attached hereto.

 was filed on _____ as Application Serial No. _____ and was

amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

10034471-122801

PRIOR FOREIGN APPLICATION(S)

Country	Number	Date Filed	Priority Claimed	
			Yes	No
_____	_____	_____	_____	_____
_____	_____	_____	_____	_____

I hereby claim the benefit under Title 35, United States Code Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

Application Serial No.	Filing Date	Status
_____	_____	_____
_____	_____	_____

And I hereby appoint Glenn W. Ohlson, Registration No. 28,455, Thomas E. Smith, Registration No. 18,243, Dennis M. McWilliams, Registration No. 25,195, James R. Sweeney, Registration No. 18,721, William M. Lee, Jr., Registration No. 26,935, David C. Brezina, Registration No. 34,128, Jeffrey R. Gray, Registration No. 33,391, Gerald S. Geren, Registration No. 24,528, Robert F.I. Conte, Registration No. 20,354, Timothy J. Engling, Registration No. 39,970, Peter J. Shakula, Registration No. 40,808, Howard B. Rockman, Registration No. 22,190, Mark A. Hagedorn, Registration No. 44,731, John W. Hayes, Registration No. 33,900, David F. Janci,

Registration No. 28,620 and John M. Lorenzen, Registration No. 25,889, as my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith. It is requested that all communications be directed to Glenn W. Ohlson of Lee, Mann, Smith, McWilliams, Sweeney & Ohlson, PO Box 2786, Chicago, Illinois 60690-2786, telephone number (312) 368-1300.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor: Alan C. Wendt

Signature Alan C. Wendt Date 12/28/01

Country of Residence: United States of America

Country of Citizenship: United States of America

Post Office and Residence Address: 249 S. Poteet Road, Barrington, IL 60010

Full name of joint inventor:

Signature _____ Date _____

Country of Residence:

Country of Citizenship:

Post Office and Residence Address: